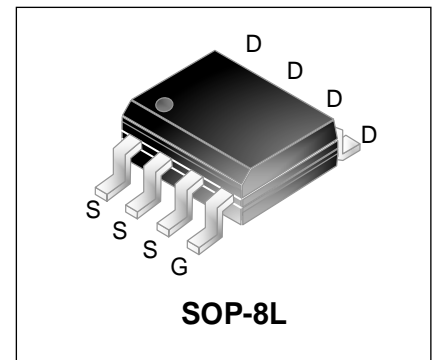


40V N-Channel Enhancement Mode Power MOSFET

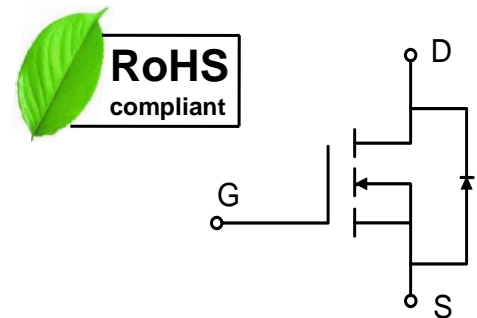
Description

WMS032N04LG2 uses Wayon's 2nd generation power trench MOSFET technology that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance. This device is well suited for high efficiency fast switching applications.



Features

- $V_{DS} = 40V$, $I_D = 22A$
 $R_{DS(on)} < 3.2m\Omega @ V_{GS} = 10V$
 $R_{DS(on)} < 5.2m\Omega @ V_{GS} = 4.5V$
- Green Device Available
- Low Gate Charge
- 100% EAS Guaranteed



Applications

- Power Management Switches
- DC/DC Converter

Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	40	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current@10V ¹	I_D	$T_A=25^\circ C$	22
		$T_A=75^\circ C$	18
Pulsed Drain Current ²	I_{DM}	165	A
Single Pulse Avalanche Energy ³	EAS	151	mJ
Avalanche Current	I_{AS}	55	A
Total Power Dissipation ⁴	P_D	22	W
Operating Junction and Storage Temperature Range	T_J, T_{STG}	-55 to 150	$^\circ C$

Thermal Characteristics

Parameter	Symbol	Value	Unit
Thermal Resistance from Junction-to-Ambient ¹	$R_{\theta JA}$	76	$^\circ C/W$
Thermal Resistance from Junction-to-Case ¹	$R_{\theta JC}$	41	$^\circ C/W$

Electrical Characteristics $T_c = 25^\circ\text{C}$, unless otherwise noted

Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit	
Static Characteristics							
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	40	-	-	V	
Gate-Body Leakage current	I_{GSS}	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	± 100	nA	
Zero Gate Voltage Drain Current	$T_J=25^\circ\text{C}$	I_{DSS}	$V_{DS} = 40V, V_{GS} = 0V$	-	-	1	μA
	$T_J=55^\circ\text{C}$			-	-	5	
Gate-Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	1.2	1.85	2.2	V	
Drain-Source on-Resistance ²	$R_{DS(on)}$	$V_{GS} = 10V, I_D = 15A$	-	2.6	3.2	m Ω	
		$V_{GS} = 4.5V, I_D = 10A$	-	3.7	5.2		
Forward Transconductance ²	g_{fs}	$V_{DS} = 5V, I_D = 20A$	-	76	-	S	
Dynamic Characteristics							
Input Capacitance	C_{iss}	$V_{DS} = 20V, V_{GS} = 0V, f = 1MHz$	-	2700	-	μF	
Output Capacitance	C_{oss}		-	1050	-		
Reverse Transfer Capacitance	C_{rss}		-	45	-		
Switching Characteristics							
Gate Resistance	R_g	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$	-	0.7	-	Ω	
Total Gate Charge	Q_g	$V_{GS} = 4.5V, V_{DS} = 20V, I_D = 20A$	-	22.5	-	nC	
Gate-Source Charge	Q_{gs}		-	7.6	-		
Gate-Drain Charge	Q_{gd}		-	5.4	-		
Turn-on Delay Time	$t_{d(on)}$	$V_{GS} = 10V, V_{DS} = 20V, R_G = 3\Omega, I_D = 20A$	-	9.8	-	nS	
Rise Time	t_r		-	5.2	-		
Turn-off Delay Time	$t_{d(off)}$		-	32	-		
Fall Time	t_f		-	6.6	-		
Drain-Source Body Diode Characteristics							
Diode Forward Voltage ²	V_{SD}	$I_S = 1A, V_{GS} = 0V$	-	-	1	V	
Continuous Source Current ^{1,5}	I_S	$V_G = V_D = 0V$, Force Current	-	-	22	A	

Notes:

- The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- The data tested by pulsed, pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$
- The EAS data shows Max. rating. The test condition is $V_{DD}=25V, V_{GS}=10V, L=0.1mH, I_{AS}=55A$
- The power dissipation is limited by 150°C junction temperature
- The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.

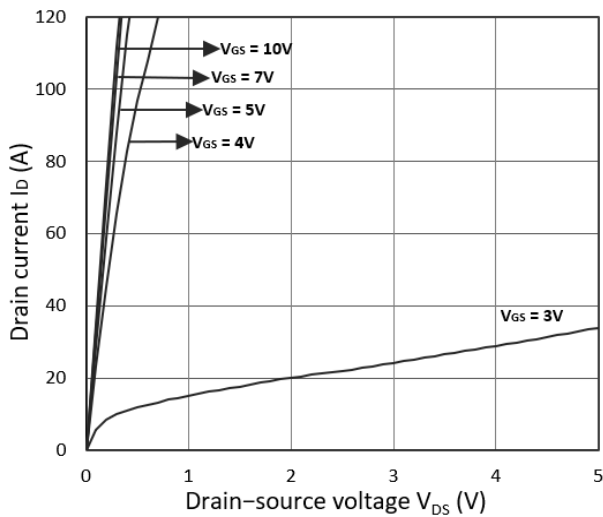


Figure 1. Output Characteristics

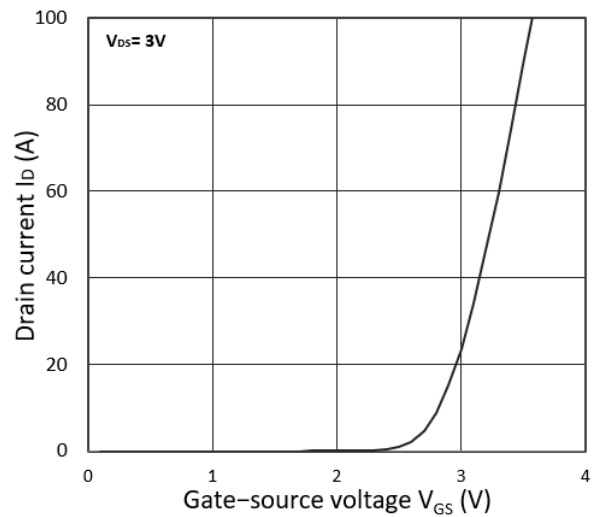


Figure 2. Transfer Characteristics

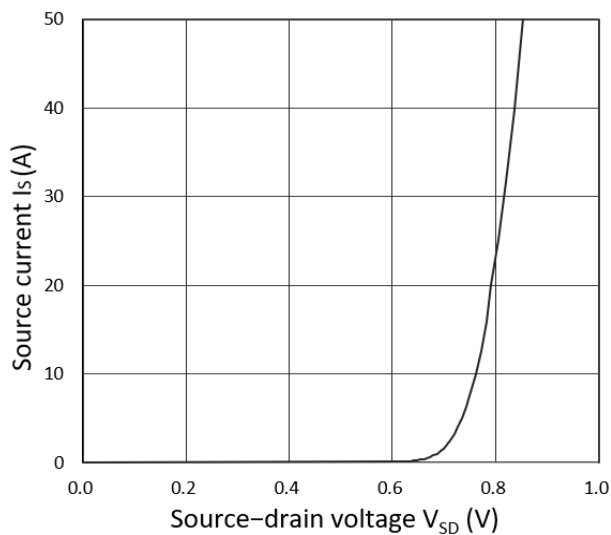


Figure 3. Forward Characteristics of Reverse

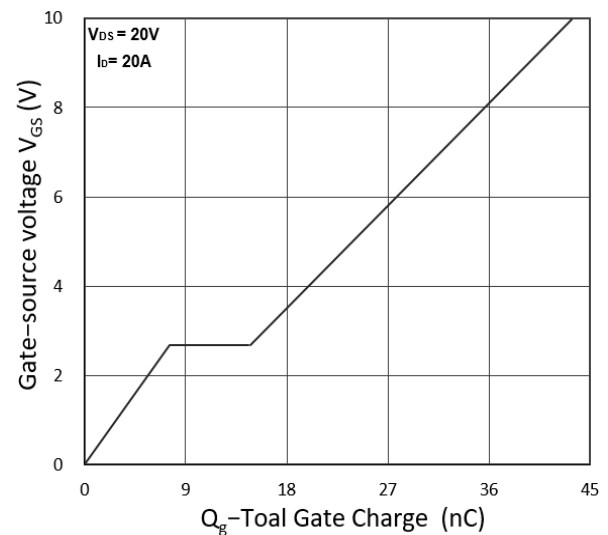


Figure 4. Gate Charge Characteristics

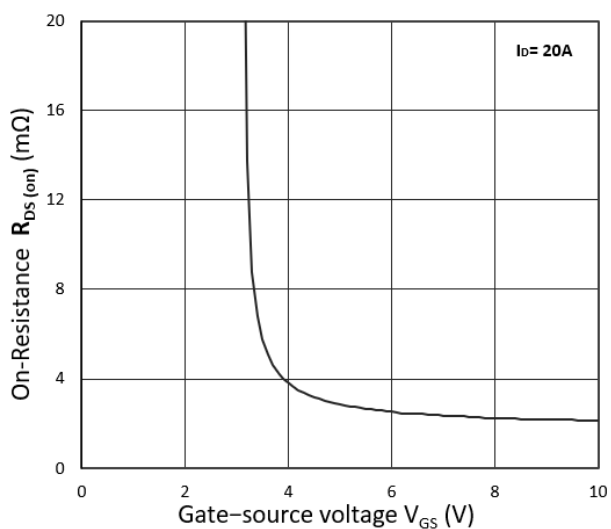


Figure 5. $R_{DS(on)}$ vs. V_{GS}

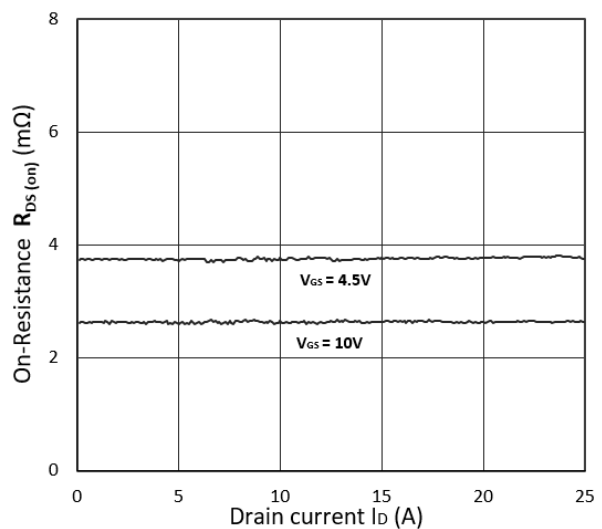


Figure 6. $R_{DS(on)}$ vs. I_D

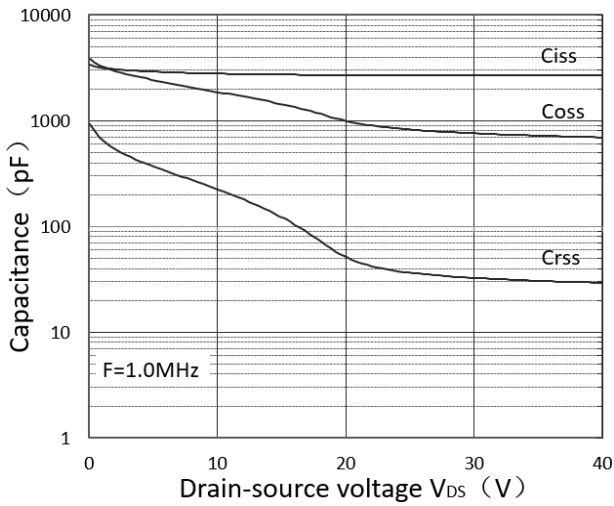


Figure 7. Capacitance Characteristics

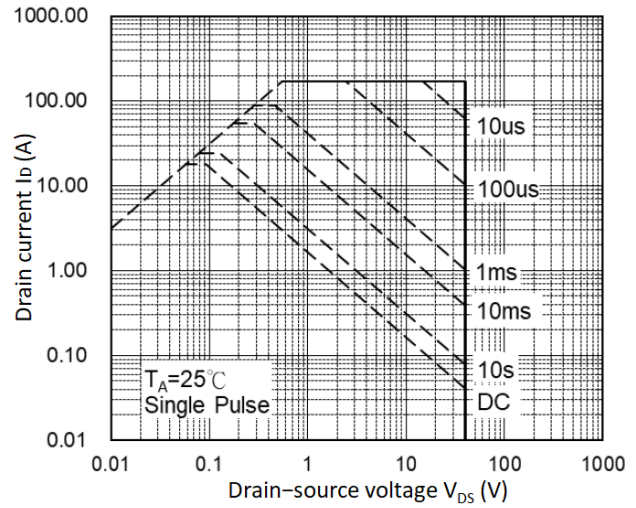


Figure 8. Safe Operating Area

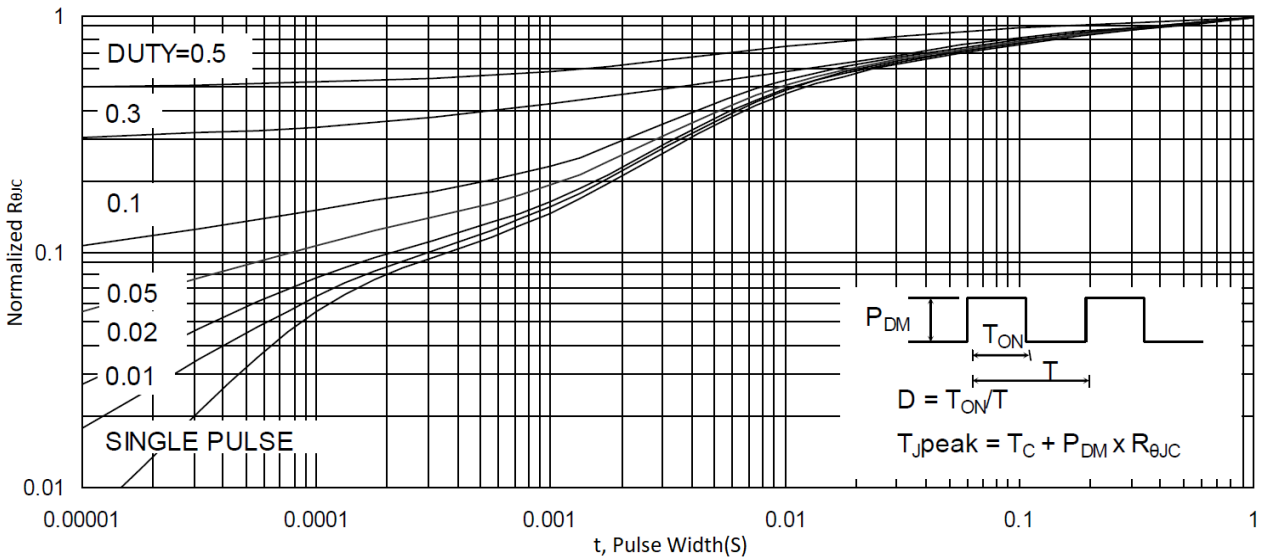


Figure 9. Normalized Maximum Transient Thermal Impedance

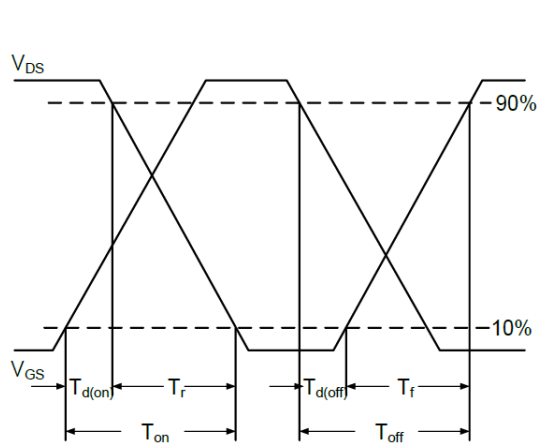


Figure 10. Switching Time Waveform

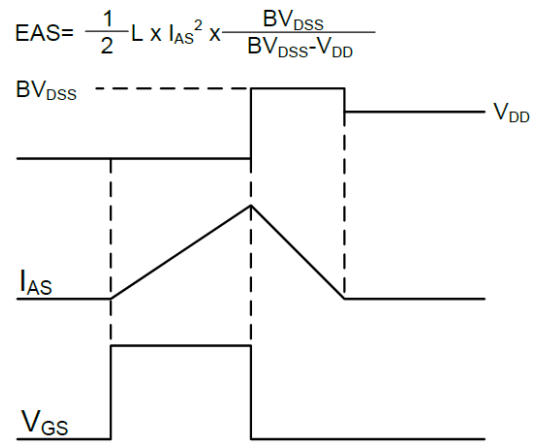
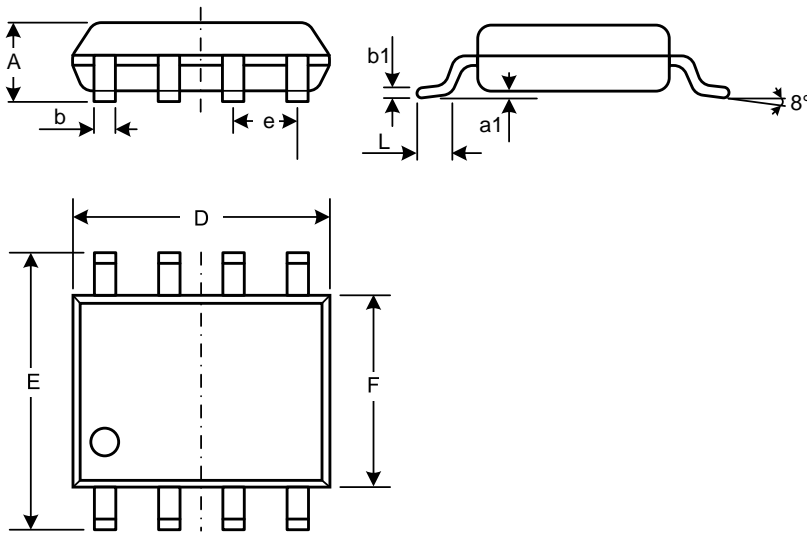


Figure 11. Unclamped Inductive Switching Waveform

$$EAS = \frac{1}{2} L \times I_{AS}^2 \times \frac{BV_{DSS}}{BV_{DSS} - V_{DD}}$$

Mechanical Dimensions for SOP-8L

COMMON DIMENSIONS

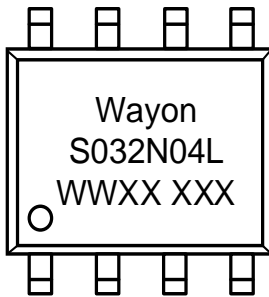


SYMBOL	MM	
	MIN	MAX
A	1.23	1.75
a1	0.05	0.25
b	0.31	0.51
b1	0.16	0.25
D	4.70	5.15
E	5.75	6.25
e	1.07	1.47
F	3.70	4.10
L	0.4	1.27

Ordering Information

Part	Package	Marking	Packing method
WMS032N04LG2	SOP-8L	S032N04L	Tape and Reel

Marking Information



S032N04L = Device code

WWXX XXX= Date code


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